



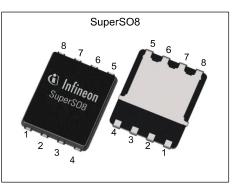
MOSFET

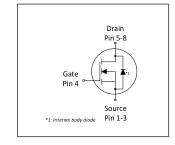
OptiMOS[™] 5 Power-Transistor, 150 V

Features

- N-channel, normal level

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 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 Very low reverse recovery charge (Qrr)
 150 °C operating temperature
 Pb-free lead plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target application
 Ideal for high-frequency switching and synchronous rectification









Type / Ordering Code	Package	Marking	Related Links
BSC160N15NS5	PG-TDSON-8	160N15NS	-

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	150	V
R _{DS(on),max}	16	mΩ
ID	56	A
Q _{rr}	25.7	nC



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1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2Maximum ratings

Demonstern	Oh. a l	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	I _D	-	-	56 36	A	<i>T</i> _C =25 °C <i>T</i> _C =100 °C
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	224	A	<i>T</i> _c =25 °C
Avalanche energy, single pulse ²⁾	EAS	-	-	43	mJ	/ _D =50 A, <i>R</i> _{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	Ptot	-	-	96	W	<i>T</i> _c =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Devenue de r	Course had	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	0.78	1.3	K/W	-
, 6 cm² cooling area ³⁾	R _{thJA}	-	-	50	K/W	-

Electrical characteristics 3

at T_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	Course had		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA
Gate threshold voltage	V _{GS(th)}	3.0	3.8	4.6	V	V _{DS} =V _{GS} , <i>I</i> _D =60 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	13.7 15.1	16 18.5	mΩ	V _{GS} =10 V, <i>I</i> _D =28 A, V _{GS} =8 V, <i>I</i> _D =14 A
Gate resistance ⁴⁾	R _G	-	1	1.5	Ω	-
Transconductance	g_{fs}	20	40	-	S	V _{DS} >2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =28 A

¹⁾ See Diagram 3 for more detailed information
 ²⁾ See Diagram 13 for more detailed information
 ³⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection.

PCB is vertical in still air. ⁴⁾ Defined by design. Not subject to production test

OptiMOS[™] 5 Power-Transistor, 150 V BSC160N15NS5



Dynamic characteristics Table 5

Parameter	Course had		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	1370	1820	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	341	454	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	Crss	-	9.6	17	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	9.6	-	ns	V_{DD} =75 V, V_{GS} =10 V, I_{D} =28 A, $R_{\text{G,ext}}$ =3 Ω
Rise time	tr	-	3	-	ns	V_{DD} =75 V, V_{GS} =10 V, I_{D} =28 A, $R_{\text{G,ext}}$ =3 Ω
Turn-off delay time	$t_{\rm d(off)}$	-	10.8	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =28 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	2.6	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =28 A, $R_{\rm G,ext}$ =3 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Symbol		Values			Note / Toot Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	8	-	nC	V_{DD} =75 V, I_{D} =28 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	4	5.9	nC	V_{DD} =75 V, I_{D} =28 A, V_{GS} =0 to 10 V
Switching charge	Qsw	-	7.8	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =28 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	19	23.1	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =28 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.8	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =28 A, $V_{\rm GS}$ =0 to 10 V
Output charge ¹⁾	Qoss	-	51	68.2	nC	V _{DD} =75 V, V _{GS} =0 V

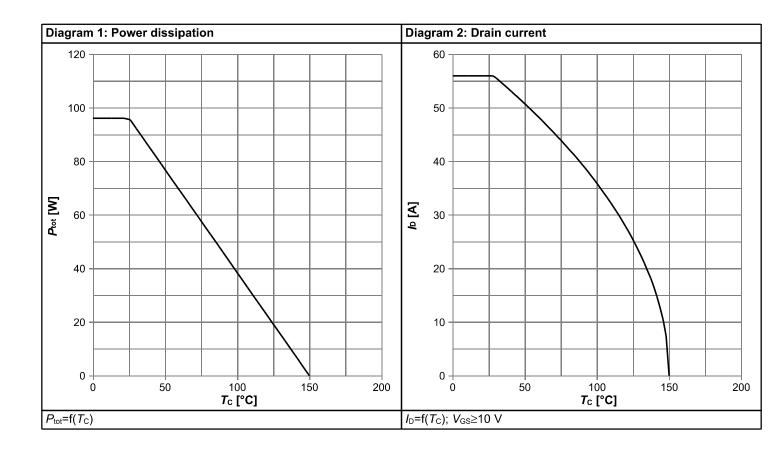
Reverse diode Table 7

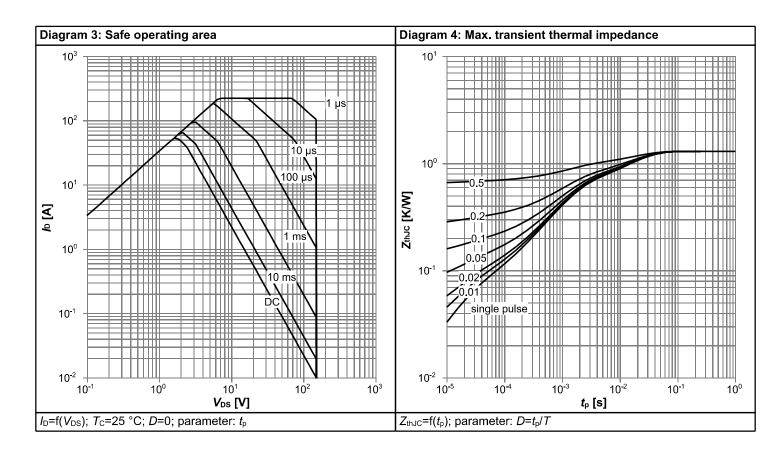
Parameter	Cumhal		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	I _S	-	-	66	A	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	224	A	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.88	1.2	V	V _{GS} =0 V, <i>I</i> _F =28 A, <i>T</i> _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	30.5	61	ns	V _R =75 V, I _F =28, d <i>i</i> _F /d <i>t</i> =100 A/µs
Reverse recovery charge ¹⁾	Qrr	-	25.7	51.4	nC	V _R =75 V, <i>I</i> _F =28, d <i>i</i> _F /d <i>t</i> =100 A/µs

 $^{1)}$ Defined by design. Not subject to production test $^{2)}$ See "Gate charge waveforms" for parameter definition

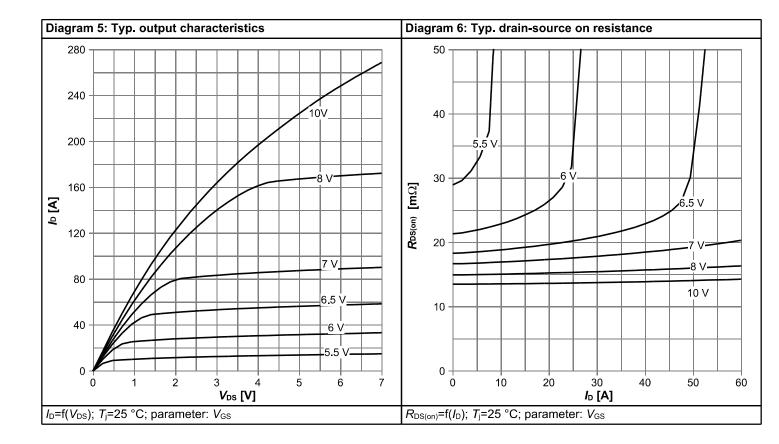


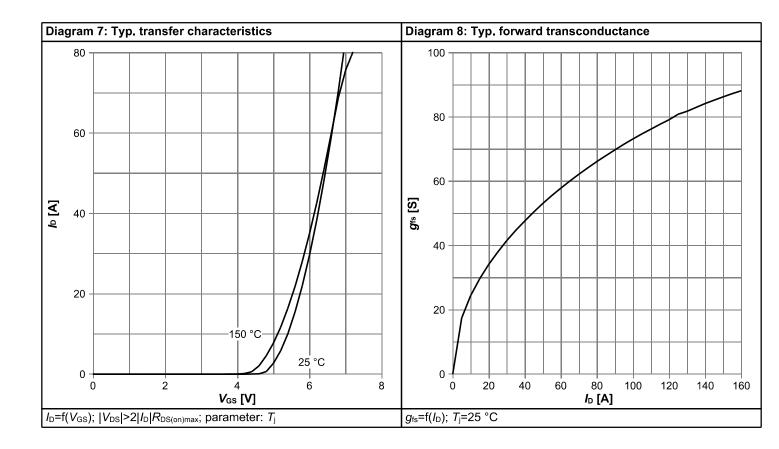
4 Electrical characteristics diagrams



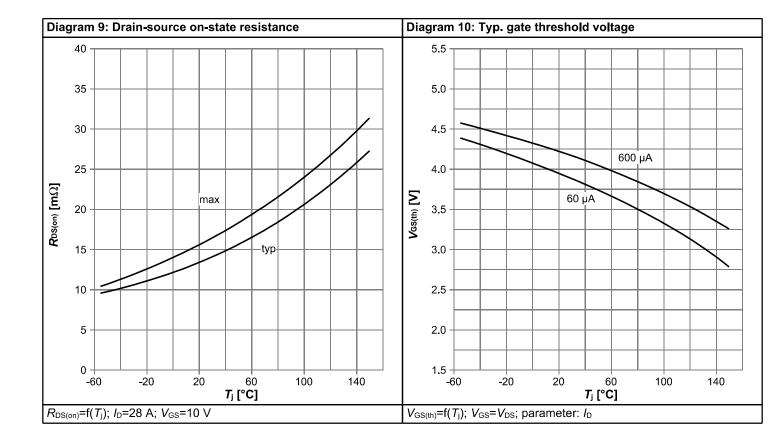


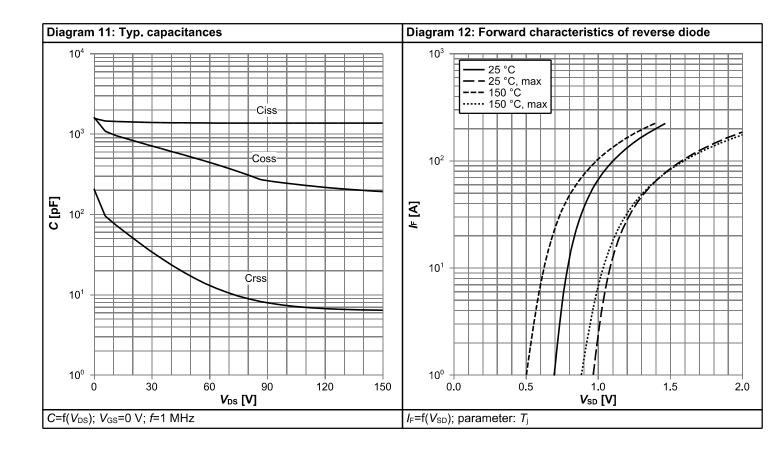




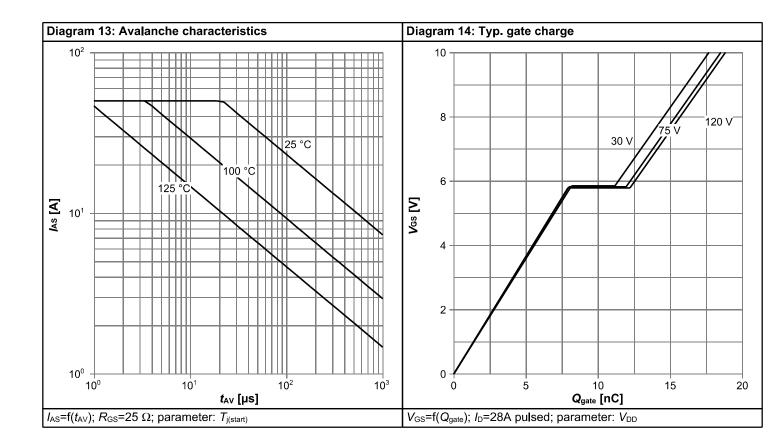


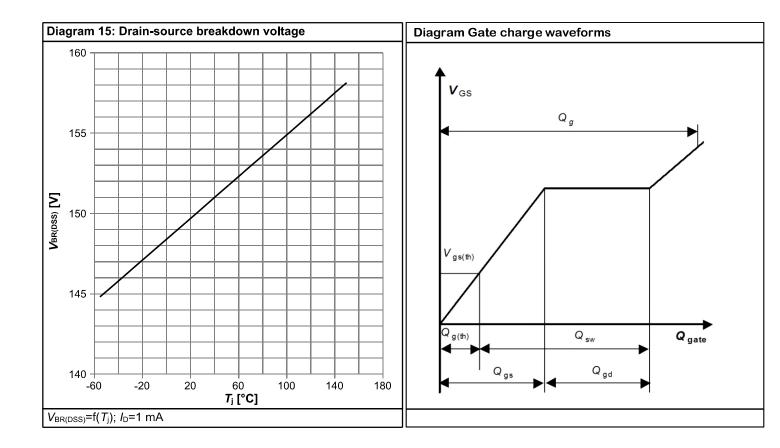






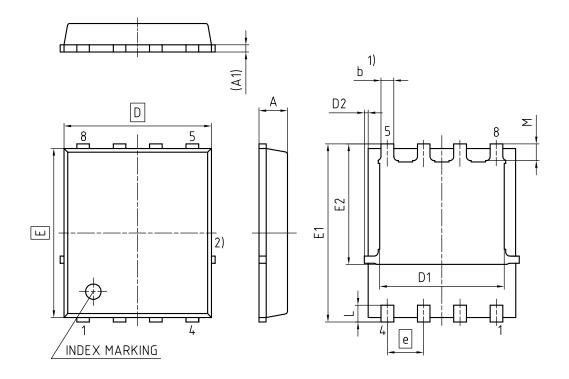








5 Package Outlines



 EXCLUDING MOLD FLASH
 REMOVAL ON MOLD GATE INTRUSION 0.1 MM PROTRUSION 0.1 MM
 LEAD LENGTH UP TO ANTI FLASH LINE ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

DIMENSION	MILLIM	IETERS				
DIMENSION	MIN.	MAX.				
A	0.90	1.20				
A1	0.15	0.35				
b	0.34	0.54				
D	4.80	5.35				
D1	3.90	4.40				
D2	0.03	0.23				
E	5.70	6.10				
E1	5.90	6.42				
E2	3.88	4.31				
e	1.27					
L	0.45 0.71					
М	0.45	0.69				

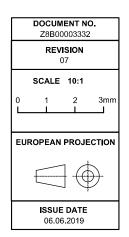


Figure 1 Outline PG-TDSON-8, dimensions in mm



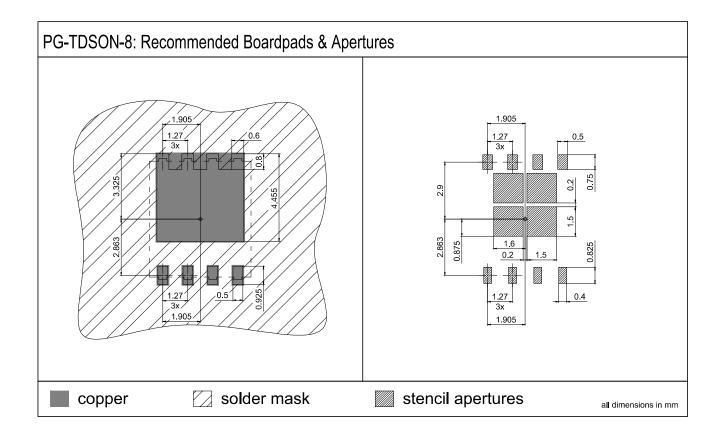
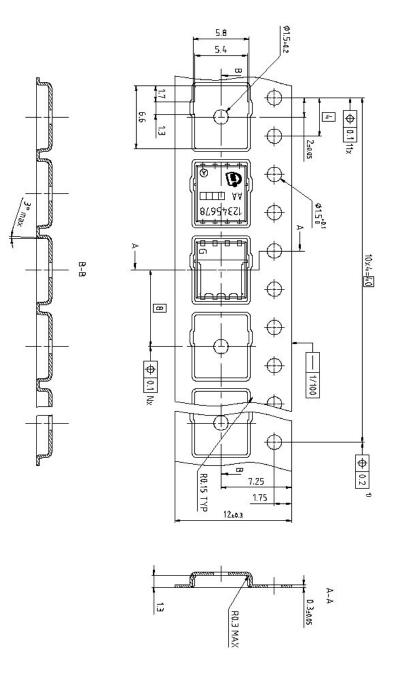


Figure 2 Outline Boardpads (TDSON-8), dimensions in mm





Dimension in mm

Figure 3 Outline Tape (TDSON-8)



Revision History

BSC160N15NS5

Revision: 2021-05-20, Rev. 2.4

Previous F	Previous Revision						
Revision	Date Subjects (major changes since last revision)						
2.0	2015-09-23	Release of final version					
2.1	2015-10-12	Rev. 2.1					
2.2	2016-01-22	Update Diagram 13					
2.3	2020-02-19	Update package drawings					
2.4	2021-05-20	Update Diagram 11 and forward current					

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